





COMPLEMENTARY 40V HIGH PERFORMANCE TRANSISTOR

Features and Benefits

NPN Transistor

- BV_{CEO} > 40V
- I_C = 3A Continuous Collector Current
- Low Saturation Voltage (500mV max @ 1A)
- R_{SAT} = 195mΩ for a low equivalent On-Resistance

PNP Transistor

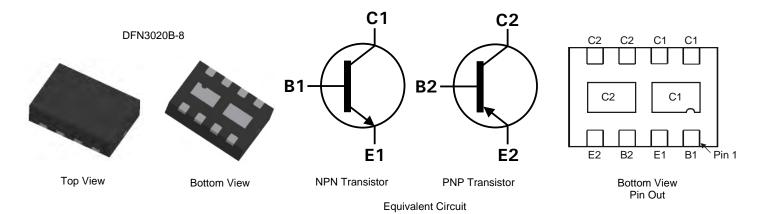
- BV_{CEO} > -40V
- I_C = -3A Continuous Collector Current
- Low Saturation Voltage (-500mV max @ -1A)
- $R_{SAT} = 350 \text{m}\Omega$ for a low equivalent On-Resistance
- h_{FE} characterized up to 2A for high current gain hold up
- Low profile 0.8mm high package for thin applications
- R_{θJA} efficient, 40% lower than SOT26
- 6mm² footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: DFN3020B-8
- Case material: Molded Plastic. "Green" Molding Compound.
- Terminals: Pre-Plated NiPdAu leadframe.
- Nominal package height: 0.8mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.013 grams (approximate)

Applications

- DC DC Converters
- Charging circuits
- Power switches
- LED Backlighting circuits
- Motor control
- Portable applications



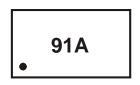
Ordering Information (Note 3)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC4591AMCTA	91A	7	8	3000

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com
- 3. For Packaging Details, go to our website at http://www.diodes.com.

Marking Information



91A = Product type marking code Top view, dot denotes pin 1





Maximum Ratings @ T_A = 25°C unless otherwise specified

Parameter	Symbol	NPN	PNP	Unit		
Collector-Base Voltage		V_{CBO}	40	-40		
Collector-Emitter Voltage		V_{CEO}	40	-40	V	
Emitter-Base Voltage		V_{EBO}	5	-5		
Peak Pulse Current		I _{CM}	3	-3		
Continuous Collector Current	(Notes 4 & 7)	- I _C	2	-1.5	Α	
Continuous Collector Current	(Notes 5 & 7)		2.5	-2		
Base Current		lΒ	30	00	mA	

Thermal Characteristics @ TA = 25°C unless otherwise specified

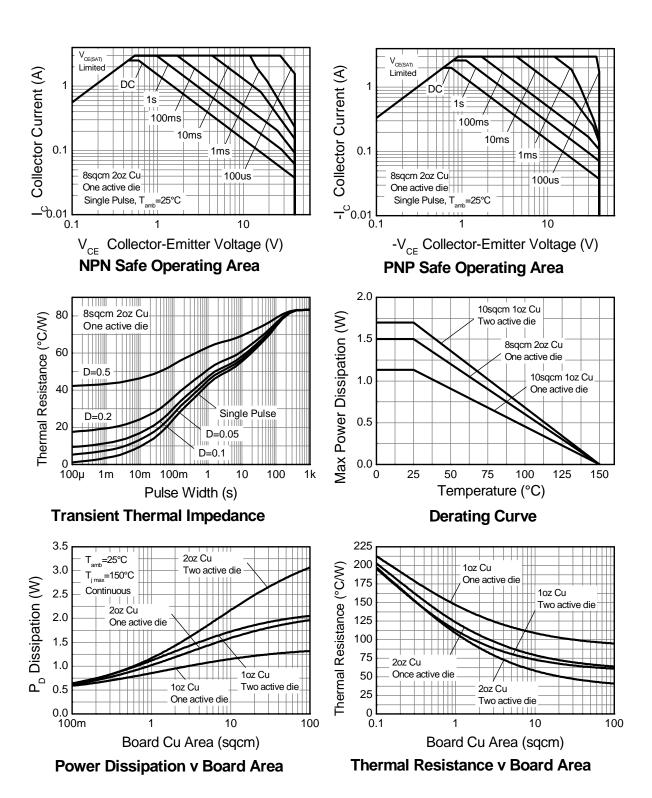
Characteristic	Symbol	NPN	PNP	Unit	
	(Notes 4 & 7)		1.5 12 2.45 19.6 1.13 8		W mW/°C
Power Dissipation	(Notes 5 & 7)				
Linear Derating Factor	(Notes 6 & 7)	P _D			
	(Notes 6 & 8)	(Notes 6 & 8)		1.7 13.6	
	(Notes 4 & 7)		83.3 51.0 111 73.5		°C/W
The second Decistance I leasting to Auchinet	(Notes 5 & 7)				
Thermal Resistance, Junction to Ambient	(Notes 6 & 7)	$R_{ hetaJA}$			
	(Notes 6 & 8)				
Thermal Resistance, Junction to Lead (Notes 7 & 9)		$R_{ heta JL}$	17.1		1
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to -	⊦ 150	°C	

Notes:

- 4. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector pads connected to each half.
- 5. Same as note (3), except the device is measured at t <5 sec.
- 6. Same as note (3), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper.
- 7. For a dual device with one active die.
- 8. For dual device with 2 active die running at equal power.
- 9. Thermal resistance from junction to solder-point (at the end of the collector lead).



Thermal Characteristics







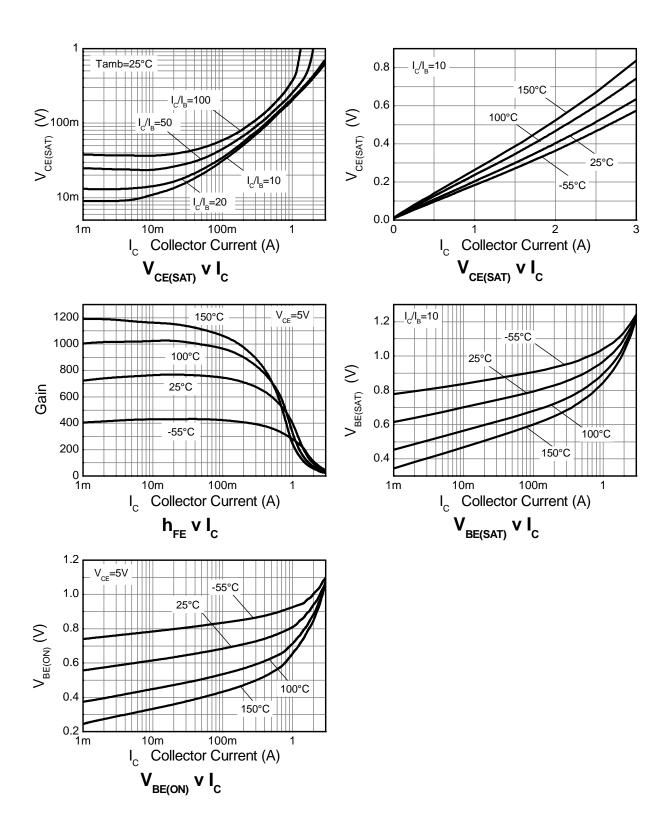
NPN - Electrical Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	40	-	-	V	$I_{C} = 100 \mu A$
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	40	-	-	V	$I_C = 10mA$
Emitter-Base Breakdown Voltage	BV_{EBO}	5	-	-	V	$I_E = 100\mu A$
Collector Cutoff Current	I _{CBO}	-	-	100	nA	V _{CB} = 30V
Emitter Cutoff Current	I _{EBO}	-	-	100	. nA	V _{EB} = 4V
Collector Emitter Cutoff Current	I _{CES}	-	-	100	nA	V _{CE} = 30V
Static Forward Current Transfer Ratio (Note 10)	h _{FE}	300 300 200 35	- - -	900 - -	-	$\begin{split} I_{C} &= 1 \text{mA, V}_{CE} = 5 \text{V} \\ I_{C} &= 500 \text{mA, V}_{CE} = 5 \text{V} \\ I_{C} &= 1 \text{A, V}_{CE} = 5 \text{V} \\ I_{C} &= 2 \text{A, V}_{CE} = 5 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(sat)}		-	300 500	mV	$I_C = 0.5A$, $I_B = 50mA$ $I_C = 1A$, $I_B = 100mA$
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(on)}	-	-	1.0	V	$I_C = 1A, V_{CE} = 5V$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(sat)}	-	-	1.1	V	$I_C = 1A$, $I_B = 100mA$
Output Capacitance	C_obo	-	-	10	pF	V _{CB} = 10V, f = 1MHz
Transition Frequency	f _T	150	-	-	MHz	$V_{CE} = 10V, I_{C} = 50mA,$ f = 100MHz

Notes: 10. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



NPN - Typical Electrical Characteristics







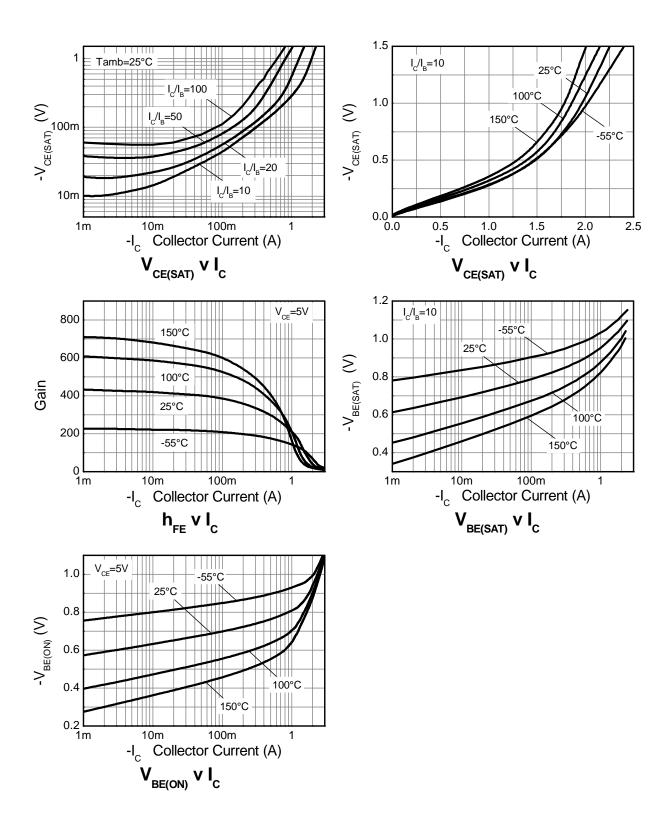
PNP - Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-40	-	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 11)	BV _{CEO}	-40	-	-	V	$I_C = -10 \text{mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	-5	-	-	V	$I_E = -100 \mu A$
Collector Cutoff Current	I _{CBO}	-	-	-100	nA	V _{CB} = -30V
Emitter Cutoff Current	I _{EBO}	-	-	-100	. nA	$V_{EB} = -4V$
Collector Emitter Cutoff Current	I _{CES}	-	-	-100	nA	V _{CE} = -30V
Static Forward Current Transfer Ratio (Note 11)	h _{FE}	300 300 250 160 30	- - - -	- 800 - - - -	-	I _C = -1mA, V _{CE} = -5V I _C = -100mA, V _{CE} = -5V I _C = -500mA, V _{CE} = -5V I _C = -1A, V _{CE} = -5V I _C = -2A, V _{CE} = -5V I _C = -0.1A, I _B = -1mA
Collector-Emitter Saturation Voltage (Note 11)	V _{CE(sat)}	-	-	-350 -500	mV	$I_C = -0.5A$, $I_B = -20mA$ $I_C = -1.0A$, $I_B = -100mA$
Base-Emitter Turn-On Voltage (Note 11)	$V_{BE(on)}$	-	-	-1.0	V	$I_C = -1A$, $V_{CE} = -5V$
Base-Emitter Saturation Voltage (Note 11)	$V_{BE(sat)}$	-	-	-1.1	V	$I_C = -1A$, $I_B = -50mA$
Output Capacitance	C_obo	-	-	10	pF	$V_{CB} = -10V$, $f = 1MHz$
Transition Frequency	f⊤	150	-	-	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 100MHz

Notes: 11. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

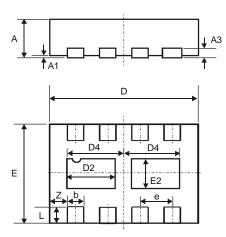


PNP - Typical Electrical Characteristics



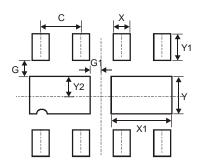


Package Outline Dimensions



DFN3020B-8					
Dim	Min	Max	Тур		
Α	0.77	0.83	0.80		
A1	0	0.05	0.02		
А3	-	-	0.15		
b	0.25	0.35	0.30		
D	2.95	3.075	3.00		
D2	0.82	1.02	0.92		
D4	1.01	1.21	1.11		
е	-	-	0.65		
Е	1.95	2.075	2.00		
E2	0.43	0.63	0.53		
L	0.25	0.35	0.30		
Z	-	-	0.375		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)				
С	0.650				
G	0.285				
G1	0.090				
Х	0.400				
X1	1.120				
Y	0.730				
Y1	0.500				
Y2	0.365				





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